

Engineering Education  
Investment Fund  
Performance Scorecard

Biennium 2001-2003

Materials Science Institute

University of Oregon

24 September 2003

Data as of 23 September 2003

# Graduate Category

	AY99	AY02	AY03	AY04	AY05*
• Student Credit Hours					
– Goal	-	880	880	1000	1100
– Projected/Actual	231	821	900	952	1456
– Variance		-58	+20		
• Degrees Awarded					
– Goal		21	21	21	21
– Projected/Actual	2	12	17(21 <sup>†</sup> )	17	26
– Variance		-9	-4	-4	-5
• Comments: Economic downturn has reduced number of internship opportunities					

\* Academic Year ending in June of the indicated year.

\*\* Actuals for AY99 & AY02. Projections for AY03, AY04, and AY05.



Number of students employed at internships (some do not complete degrees)

# Fiscal Summary

	<b>FY03</b>	<b>FY03</b>	<b>VARIANCE***</b>
	<b>AVAILABLE*</b>	<b>ACTUAL**</b>	
<b>ETIC Investments</b>	<b>\$633,707</b>	<b>\$411,320</b>	<b>\$222,387</b>
<b>Top Tier Investment</b>			
<b>ETIC &amp; Top Tier</b>	<b>\$633,707</b>	<b>\$411,320</b>	<b>\$222,387</b>

\* FY02 Carry-forward plus FY03 Budget from Revised RAM. See [http://www.oregonetic.org/current\\_investments/BudgetReductionFinal9-30-02.pdf](http://www.oregonetic.org/current_investments/BudgetReductionFinal9-30-02.pdf)

\*\* As of 6/30/03

\*\*\* Budget - Actual

# Private Support\*

Category	Description	Value
LSI Logic Corp	Misc equipment	\$113,375
Hewlett Packard	Electron Microscope	\$46,000
Planar Systems	ALD System	\$100,000
Hynix Semiconductor Manufacturing America	Scholarships	\$30,000
Hewlett Packard	FIB	\$60,000
Hewlett Packard	KLA Tensor Superscan & Axic Tiger	\$11,000

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Total for FY03

\$0

Received in FY02

\$360,375

Received in Biennium 01-03

\$360,375

Biennium Goal\*\*

Variance\*\*\*

\* Per Policy on Private Support Reporting <http://www.oregonetic.org/mission/eticprivatematch5.pdf>

\*\* From ETIC Plan for 2001-2003 Biennium

Additional Private Support: Internships

Willamette Valley Company – 2 internships

Bend Research – 2 internships

Pacific Northwest National Labs – 1 internship

CW Group – 1 internship

Dynea – 2 internships

Hynix Semiconductor America – 9 internships

TriQuint Semiconductor - 2 internships

Network Elements – 1 internship [Slide 5](#)

Intel Corp – 4 internships

Hewlett Packard – 2 internships

Molecular Probes – 2 internships

L'Oreál Paris – 1 internship

LSI Logic Corp. – 3 internships

Total Internships: 32

# Other Leverage -- Federal & Other Grants

Grantor	Description	Value
National Science Foundation	– IGERT Grant to support 15 graduate students	\$2,741,000
National Science Foundation	– IGERT International Travel Supplement	\$57,236
National Science Foundation	– CCLI Program – Mask Aligner, Wire Bonder	\$74,649
National Science Foundation	– MRI Program – SIMS System	\$500,000
National Science Foundation	– CRIF Program – X-Ray Diffractometer	\$212,175
US Dept of Education	– GAANN Materials Science Institute	\$519,426
US Dept of Education	– GAANN Chemistry Dept	\$519,426
Intel Corporation	– Semiconductor Lab Equipment	\$35,000
National Science Foundation	– POLY Camp	\$57,243
National Science Foundation	– NIRT	\$1,400,000
National Science Foundation	– CAREER Award, Heiner Linke	\$645,196
National Science Foundation	- CAREER Award, Miriam Deutsch	\$576,540
National Science Foundation	- CAREER Award, Jens Noeckel	\$399,371
National Science Foundation	GK-12 Award	\$2,800,000
Individual PI Awards		\$2,566,544
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	<b>Total</b>	<b>\$13,103,806</b>